



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

### **Product Summary**

Device	BVDSS	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
01	201/	$0.5\Omega$ @ $V_{GS} = 4.5V$	1030mA
Qi	Q1 20V	0.9Ω @ V <sub>GS</sub> = 1.8V	740mA
00	201/	1.0Ω @ V <sub>GS</sub> = -4.5V	-700mA
Q2	-20V	2.0Ω @ V <sub>GS</sub> = -1.8V	-460mA

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

### **Applications**

- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Load Switch

### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage V<sub>GS(TH)</sub> < ±1V</li>
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.003 grams (Approximate)

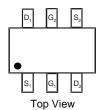


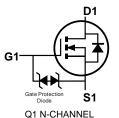


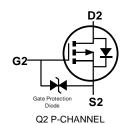
Top View



Bottom View







Equivalent Circuit

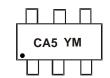
# **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMC2450UV-7	SOT563	3,000/Tape & Reel
DMC2450UV-7B	SOT563	8,000/Tape & Reel (Note 5)
DMC2450UV-13	SOT563	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. Change the pitch from 4mm to 2mm in T & R.

# **Marking Information**



CA5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

### Date Code Key

Year	2015		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	С		Н	ı	J	K	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings - Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	Drain-Source Voltage				
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Prain Current (Note 7) \/ 45\/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	1,030 800	mA
Continuous Drain Current (Note 7) $V_{GS} = 4.5V$ $t<10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			lo	1,150 900	mA
			lo	740 570	mA
Continuous Drain Current (Note 7) V <sub>GS</sub> = 1.8V	lo	870 700	mA		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	3	А		
Maximum Body Diode Continuous Current			Is	800	mA

# Maximum Ratings - Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			$V_{DSS}$	-20	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Desis Coursest (Note 7)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	-700 -550	mA
Continuous Drain Current (Note 7) V <sub>GS</sub> = -4.5V			I <sub>D</sub>	-820 -640	mA
Continuous Desis Coursest (Note 7) V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	-460 -350	mA
Continuous Drain Current (Note 7) $V_{GS} = -1.8V$ $t<10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			lo	-550 -420	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	-2	А		
Maximum Body Diode Continuous Current	Is	-800	mA		

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	P <sub>D</sub>	0.45	W	
Thormal Registance, Jungtion to Ambient (Note 6)	Steady State	Reja	281	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	Көја	210	°C/W	
Total Power Dissipation (Note 7)	PD	1	W	
Thermal Resistance, Junction to Ambient (Note 7)  Steady State t<10s		Reja	129	°C/W
		Keja	97	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	ů	

6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

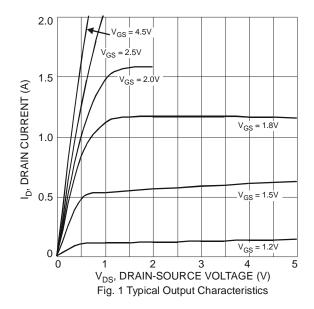


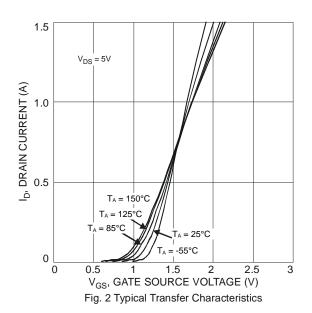
# Electrical Characteristics - Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	V <sub>G</sub> S = 0V, I <sub>D</sub> = 1mA
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Coto Course Lockers	.	_	_	±1.0		$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
Gate-Source Leakage	IGSS	_	_	±10.0	μA	V <sub>G</sub> S = ±8V, V <sub>D</sub> S = 0V
ON CHARACTERISTICS (Note 8)				•		
Gate Threshold Voltage	Vgs(TH)	0.5		0.9	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
		_	0.3	0.48		V <sub>G</sub> S = 5.0V, I <sub>D</sub> = 200mA
		_	0.35	0.5	Ω	$V_{GS} = 4.5V, I_{D} = 200mA$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	0.45	0.7		V <sub>G</sub> S = 2.5V, I <sub>D</sub> = 200mA
Static Drain-Source On-Resistance		_	0.55	0.9		V <sub>G</sub> S = 1.8V, I <sub>D</sub> = 100mA
		_	0.65	1.5		V <sub>GS</sub> = 1.5V, I <sub>D</sub> = 50mA
		_	2	_		V <sub>G</sub> S = 1.2V, I <sub>D</sub> = 1mA
Diode Forward Voltage	VsD	_	0.7	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 500mA
DYNAMIC CHARACTERISTICS (Note 9)				•		
Input Capacitance	C <sub>iss</sub>	_	37.1	_		.,
Output Capacitance	Coss	_	6.5	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	4.8	_		1 – 1.01/11/12
Gate Resistance	Rg	_	68	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ ,
Total Gate Charge	Qg	_	0.5	_		
Gate-Source Charge	Qgs	_	0.07	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge	Q <sub>gd</sub>	_	0.1	_		ID = 250MA
Turn-On Delay Time	td(ON)	_	4.06	_		
Turn-On Rise Time	t <sub>R</sub>	_	7.28	_		$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	_	13.74	_	ns	$R_L = 47\Omega$ , $R_G = 10\Omega$ , $I_D = 200\text{mA}$
Turn-Off Fall Time	tF	_	10.54	_		10 - 20011IA

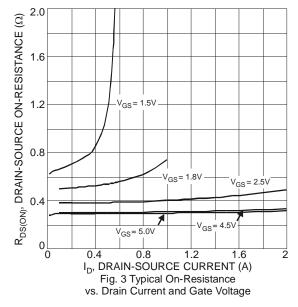
Notes:

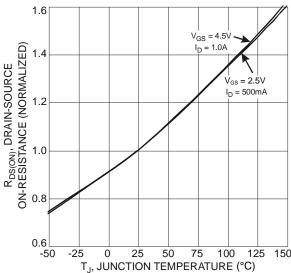
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

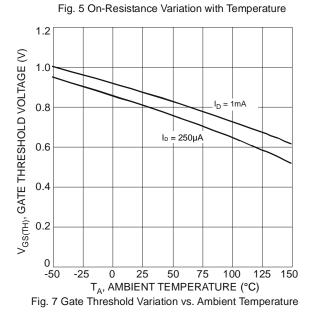












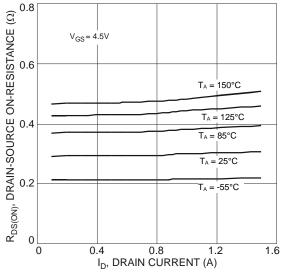


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

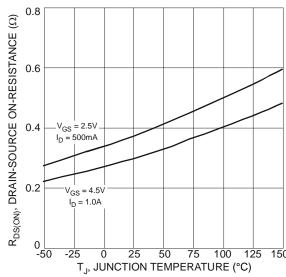
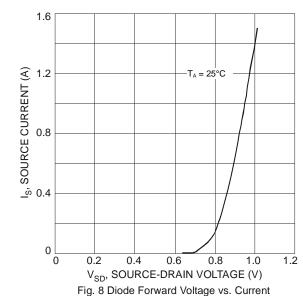
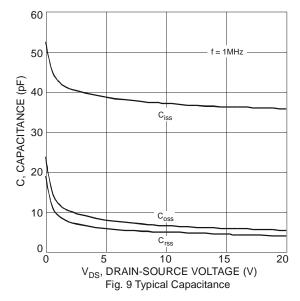


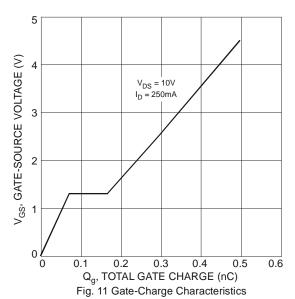
Fig. 6 On-Resistance Variation with Temperature



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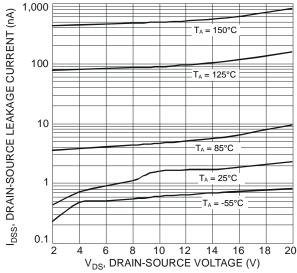
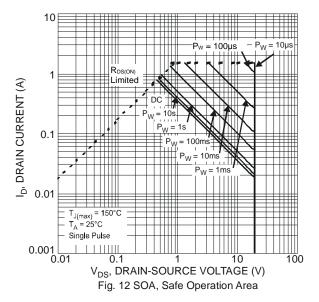


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage



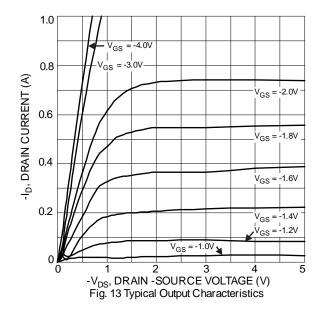


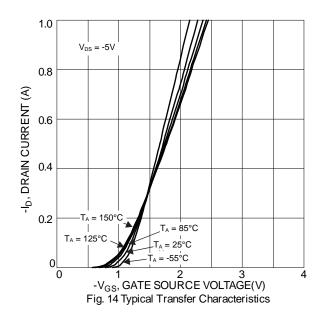
# Electrical Characteristics - Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	٧	$V_{GS} = 0V$ , $I_D = -1mA$
Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C	IDSS	_	_	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	looo	_	_	±1.0	μΑ	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
S .	I <sub>GSS</sub>		_	±10.0	μΛ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(TH)	-0.5	_	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
		_	0.67	0.97		$V_{GS} = -5V, I_{D} = -100mA$
	RDS(ON)	_	0.7	1.0		$V_{GS} = -4.5V$ , $I_D = -100mA$
Static Drain-Source On-Resistance		_	0.9	1.5	Ω	$V_{GS} = -2.5V, I_{D} = -80mA$
Static Dialii-Source Off-Resistance			1.2	2.0		$V_{GS} = -1.8V, I_D = -40mA$
		-	1.5	3.0		$V_{GS} = -1.5V, I_{D} = -30mA$
		_	5	_		$V_{GS} = -1.2V, I_{D} = -1mA$
Diode Forward Voltage	$V_{SD}$	-	-0.75	-1.2	V	$V_{GS} = 0V, I_{S} = -330mA$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		46.1	_		V 40V V 0V
Output Capacitance	Coss	-	7.2	_	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		4.9	_		1 = 1.001112
Gate Resistance	$R_g$	_	14.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$
Total Gate Charge V <sub>GS</sub> = -4.5V	Qg	_	0.5	_		
Total Gate Charge V <sub>GS</sub> = -10V	Qg	_	0.85		nC	\/ 10\/ I- 250m A
Gate-Source Charge	Qgs	_	0.09	_	IIC	$V_{DS} = -10V, I_{D} = -250mA$
Gate-Drain Charge	$Q_{gd}$	_	0.09	_		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	8.5	_		V 0V V 0.5V
Turn-On Rise Time	t <sub>R</sub>	_	4.3	_	no	$V_{DD} = -3V, V_{GS} = -2.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	20.2	_	ns	$R_L = 300\Omega$ , $R_G = 25\Omega$ , $I_D = -100 \text{mA}$
Turn-Off Fall Time	t <sub>F</sub>	_	19.2	_		ID = -TOOTIA

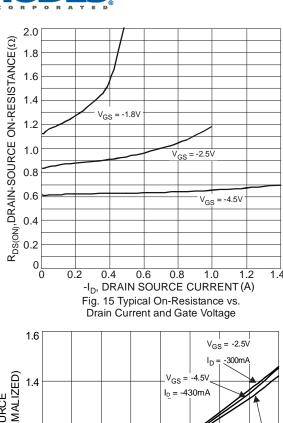
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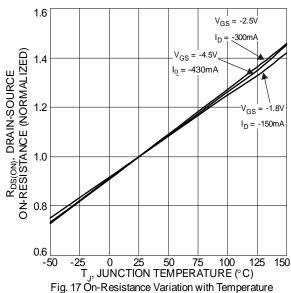
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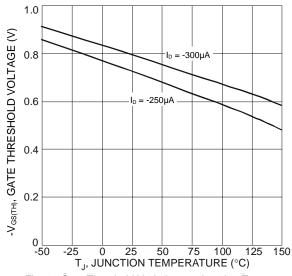
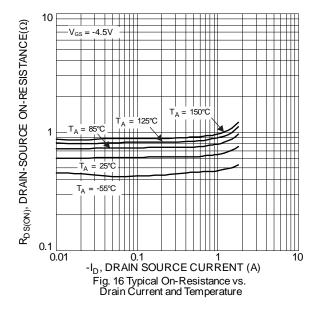
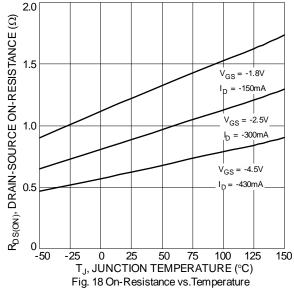
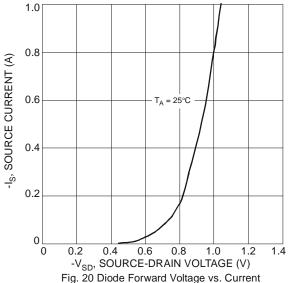


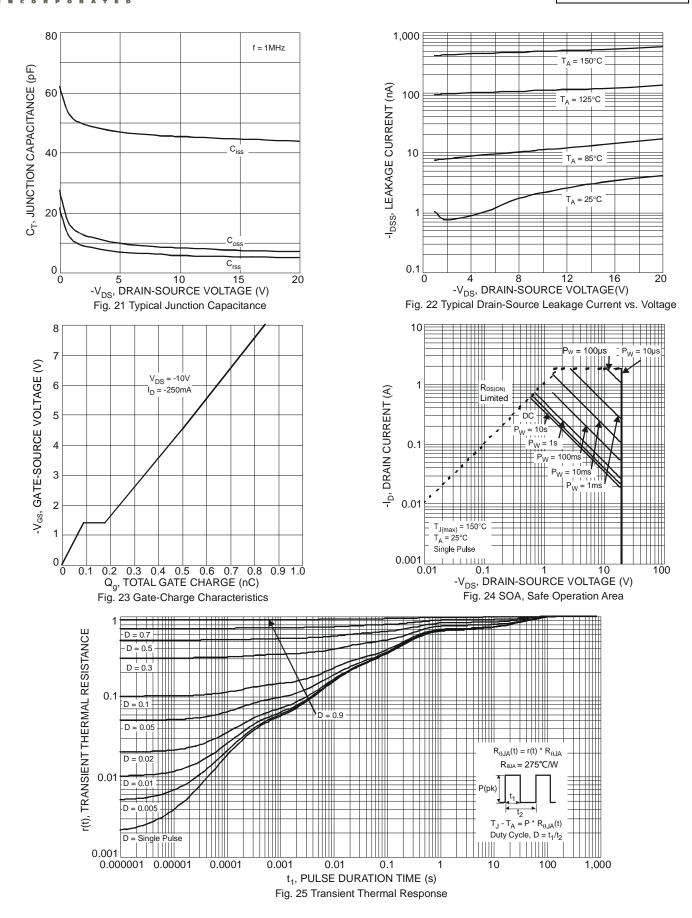
Fig. 19 Gate Threshold Variation vs. Junction Temperature









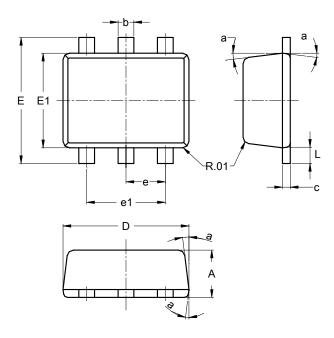




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT563**

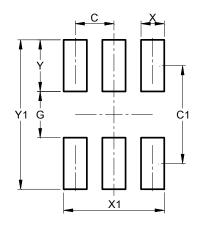


	SO	T563				
Dim	Min	Max	Тур			
Α	0.55	0.60	0.60			
b	0.15	0.30	0.20			
С	0.10	0.18	0.11			
D	1.50	1.70	1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All	All Dimensions in mm					

# **Suggested Pad Layout**

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

#### **SOT563**



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
V1	1 940



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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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